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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	32800
Total RAM Bits	434176
Number of I/O	360
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfec33e-4fn484c

Figure 2-1. Simplified Block Diagram, LatticeEC Device (Top Level)

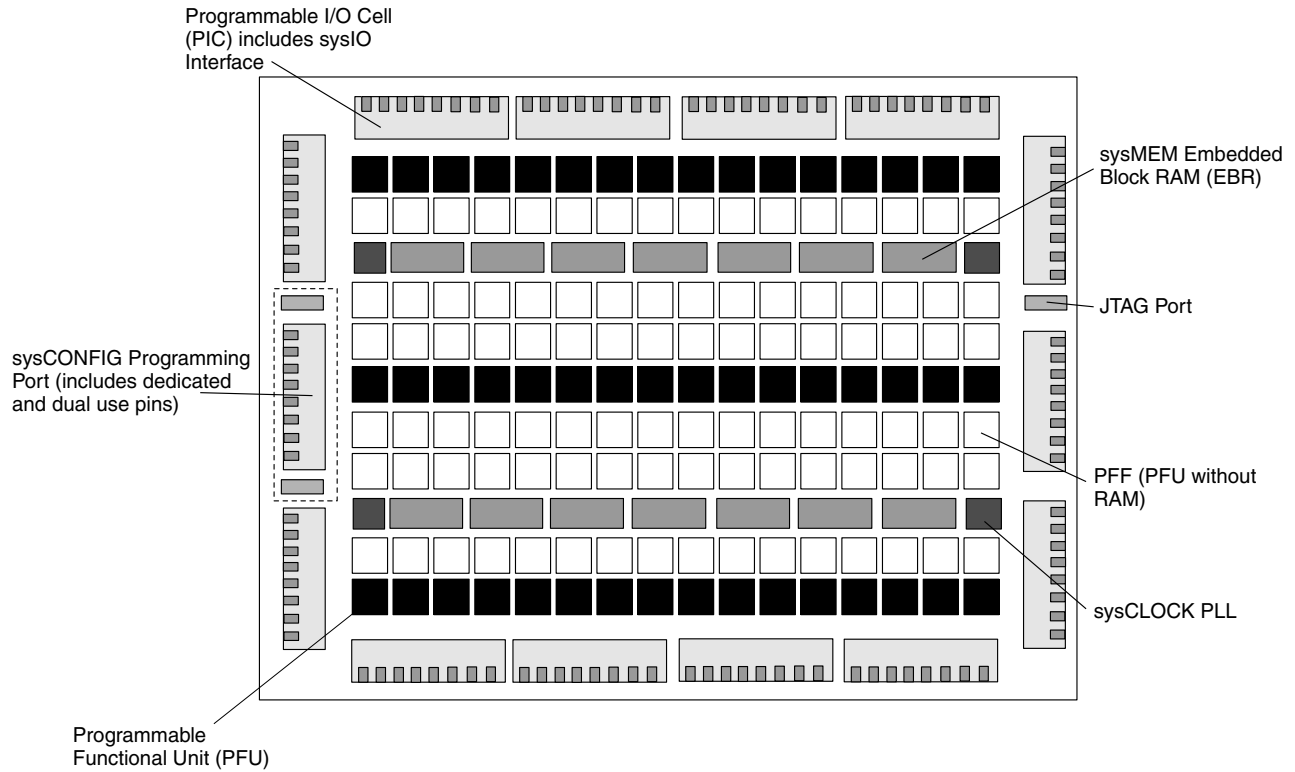


Figure 2-2. Simplified Block Diagram, LatticeECP-DSP Device (Top Level)

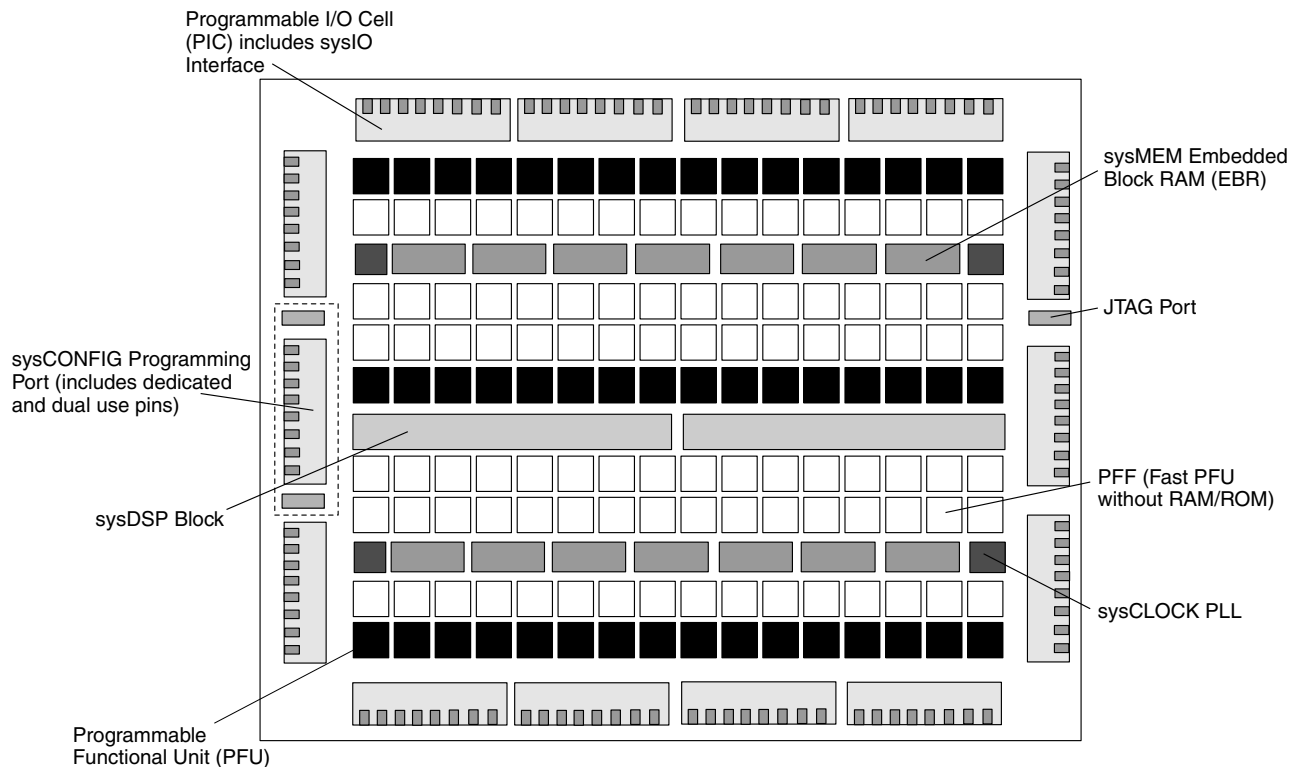


Figure 2-4. Slice Diagram

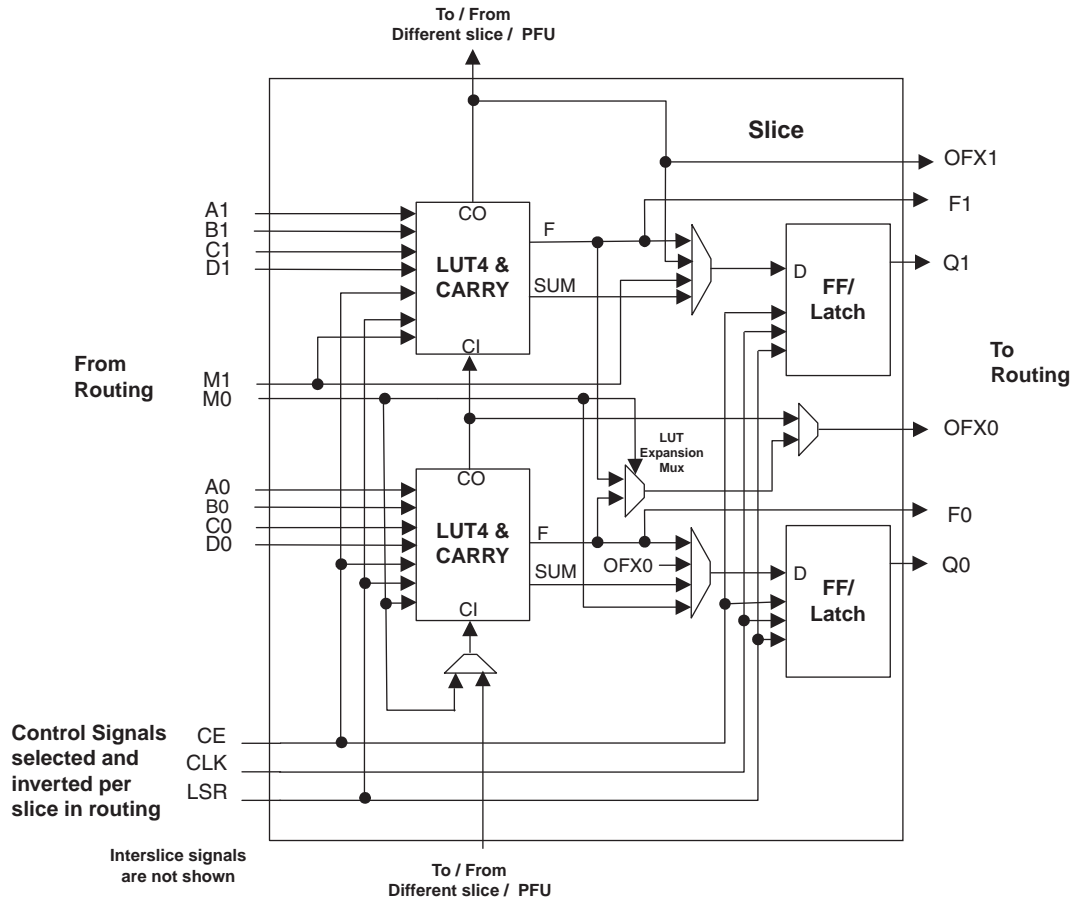


Table 2-1. Slice Signal Descriptions

Function	Type	Signal Names	Description
Input	Data signal	A0, B0, C0, D0	Inputs to LUT4
Input	Data signal	A1, B1, C1, D1	Inputs to LUT4
Input	Multi-purpose	M0	Multipurpose Input
Input	Multi-purpose	M1	Multipurpose Input
Input	Control signal	CE	Clock Enable
Input	Control signal	LSR	Local Set/Reset
Input	Control signal	CLK	System Clock
Input	Inter-PFU signal	FCIN	Fast Carry In ¹
Output	Data signals	F0, F1	LUT4 output register bypass signals
Output	Data signals	Q0, Q1	Register Outputs
Output	Data signals	OFX0	Output of a LUT5 MUX
Output	Data signals	OFX1	Output of a LUT6, LUT7, LUT8 ² MUX depending on the slice
Output	Inter-PFU signal	FCO	For the right most PFU the fast carry chain output ¹

1. See Figure 2-3 for connection details.

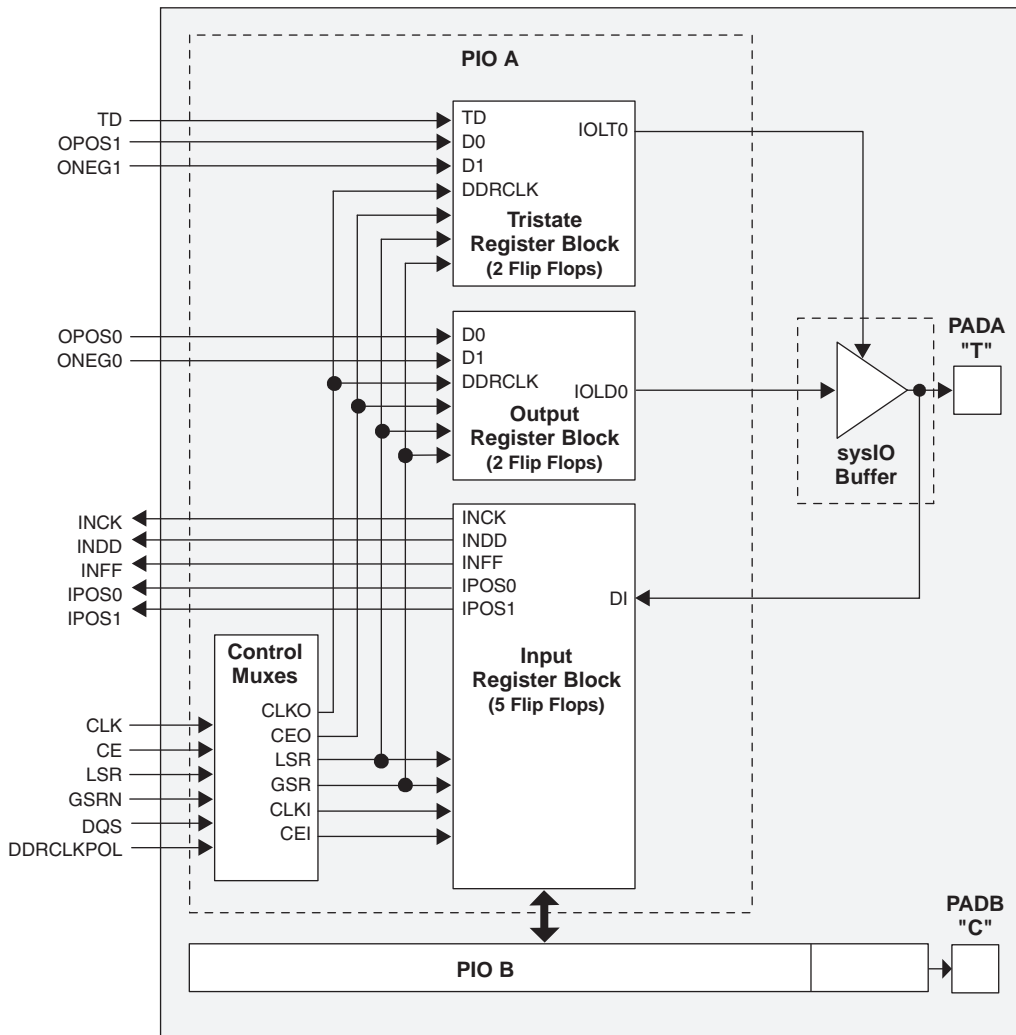
2. Requires two PFUs.

For further information about the sysDSP block, please see the list of technical information at the end of this data sheet.

Programmable I/O Cells (PIC)

Each PIC contains two PIOs connected to their respective sysI/O Buffers which are then connected to the PADs as shown in Figure 2-24. The PIO Block supplies the output data (DO) and the Tri-state control signal (TO) to sysI/O buffer, and receives input from the buffer.

Figure 2-24. PIC Diagram



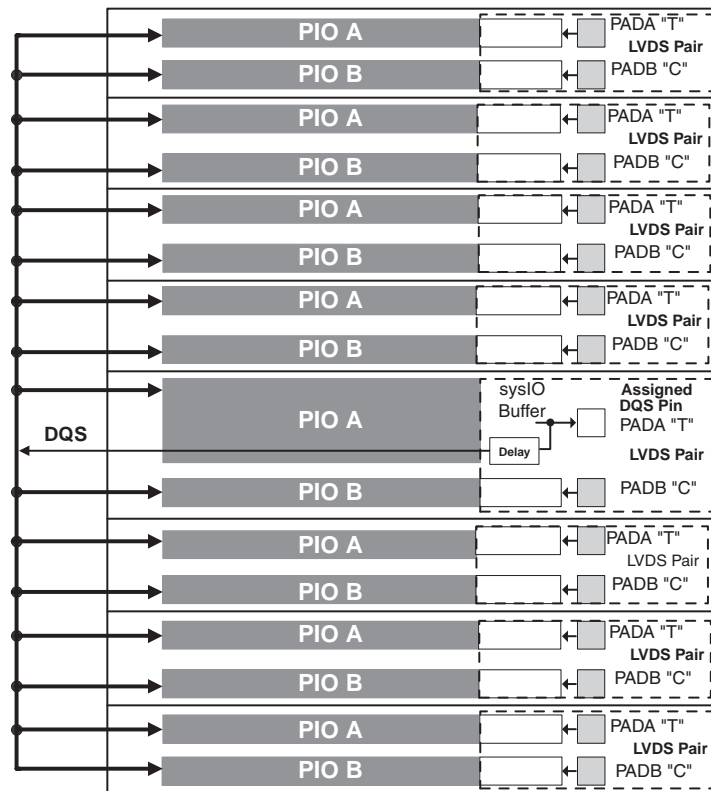
Two adjacent PIOs can be joined to provide a differential I/O pair (labeled as “T” and “C”) as shown in Figure 2-25. The PAD Labels “T” and “C” distinguish the two PIOs. Only the PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs.

One of every 16 PIOs contains a delay element to facilitate the generation of DQS signals. The DQS signal feeds the DQS bus which spans the set of 16 PIOs. Figure 2-25 shows the assignment of DQS pins in each set of 16 PIOs. The exact DQS pins are shown in a dual function in the Logic Signal Connections table at the end of this data sheet. Additional detail is provided in the Signal Descriptions table at the end of this data sheet. The DQS signal from the bus is used to strobe the DDR data from the memory into input register blocks. This interface is designed for memories that support one DQS strobe per eight bits of data.

Table 2-12. PIO Signal List

Name	Type	Description
CE0, CE1	Control from the core	Clock enables for input and output block FFs.
CLK0, CLK1	Control from the core	System clocks for input and output blocks.
LSR	Control from the core	Local Set/Reset.
GSRN	Control from routing	Global Set/Reset (active low).
INCK	Input to the core	Input to Primary Clock Network or PLL reference inputs.
DQS	Input to PIO	DQS signal from logic (routing) to PIO.
INDD	Input to the core	Unregistered data input to core.
INFF	Input to the core	Registered input on positive edge of the clock (CLK0).
IPOS0, IPOS1	Input to the core	DDR _X registered inputs to the core.
ONEG0	Control from the core	Output signals from the core for SDR and DDR operation.
OPOS0,	Control from the core	Output signals from the core for DDR operation
OPOS1 ONEG1	Tristate control from the core	Signals to Tristate Register block for DDR operation.
TD	Tristate control from the core	Tristate signal from the core used in SDR operation.
DDRCLKPOL	Control from clock polarity bus	Controls the polarity of the clock (CLK0) that feed the DDR input block.

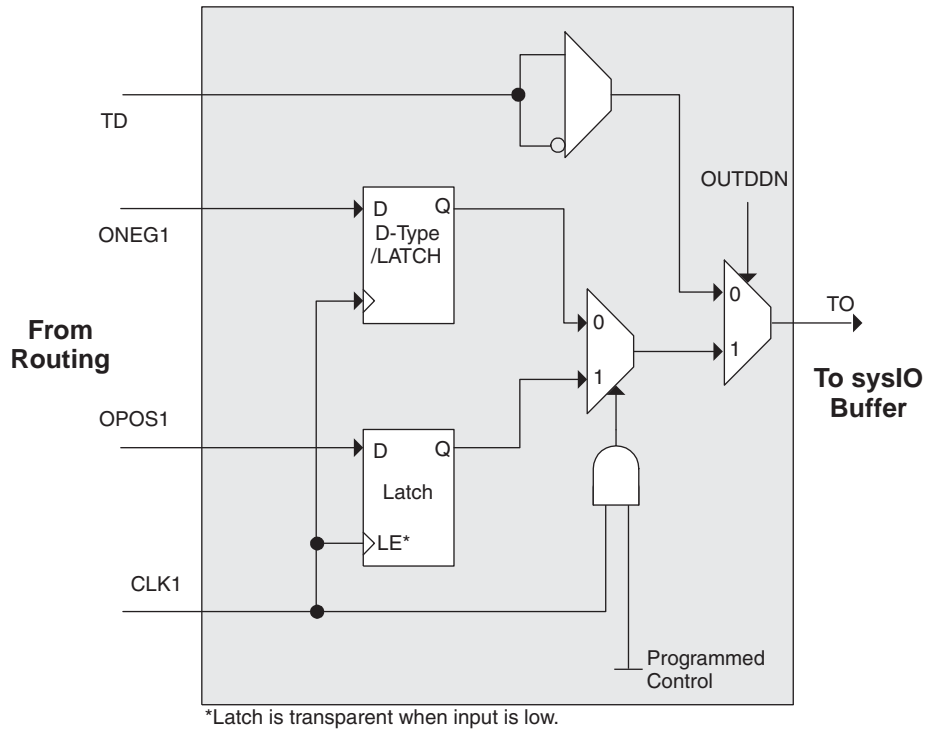
Figure 2-25. DQS Routing



PIO

The PIO contains four blocks: an input register block, output register block, tristate register block and a control logic block. These blocks contain registers for both single data rate (SDR) and double data rate (DDR) operation along with the necessary clock and selection logic. Programmable delay lines used to shift incoming clock and data signals are also included in these blocks.

Figure 2-31. Tristate Register Block



Control Logic Block

The control logic block allows the selection and modification of control signals for use in the PIO block. A clock is selected from one of the clock signals provided from the general purpose routing and a DQS signal provided from the programmable DQS pin. The clock can optionally be inverted.

The clock enable and local reset signals are selected from the routing and optionally inverted. The global tristate signal is passed through this block.

DDR Memory Support

Implementing high performance DDR memory interfaces requires dedicated DDR register structures in the input (for read operations) and in the output (for write operations). As indicated in the PIO Logic section, the LatticeEC devices provide this capability. In addition to these registers, the LatticeEC devices contain two elements to simplify the design of input structures for read operations: the DQS delay block and polarity control logic.

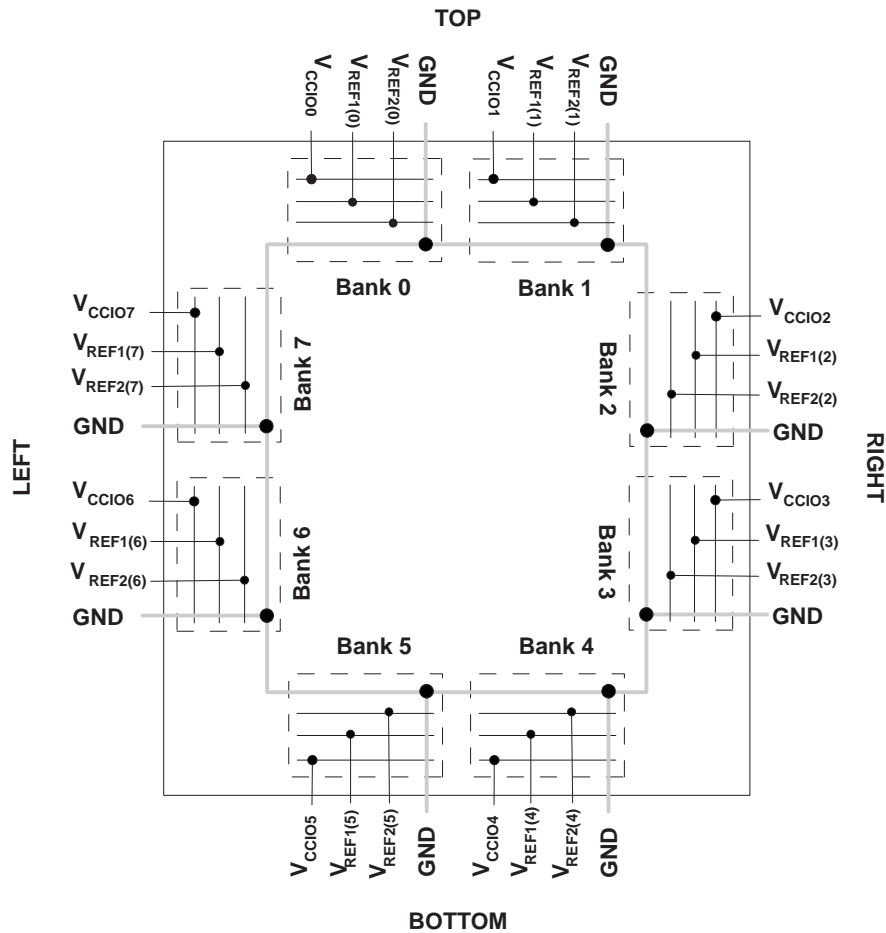
DLL Calibrated DQS Delay Block

Source Synchronous interfaces generally require the input clock to be adjusted in order to correctly capture data at the input register. For most interfaces a PLL is used for this adjustment. However in DDR memories the clock (referred to as DQS) is not free running so this approach cannot be used. The DQS Delay block provides the required clock alignment for DDR memory interfaces.

The DQS signal (selected PIOs only) feeds from the PAD through a DQS delay element to a dedicated DQS routing resource. The DQS signal also feeds polarity control logic, which controls the polarity of the clock to the sync registers in the input register blocks. Figures 2-32 and 2-33 show how the DQS transition signals are routed to the PIOs.

The temperature, voltage and process variations of the DQS delay block are compensated by a set of calibration (6-bit bus) signals from two DLLs on opposite sides of the device. Each DLL compensates DQS Delays in its half of the device as shown in Figure 2-33. The DLL loop is compensated for temperature, voltage and process variations by the system clock and feedback loop.

Figure 2-34. LatticeECP/EC Banks



LatticeECP/EC devices contain two types of sysI/O buffer pairs.

1. **Top and Bottom sysI/O Buffer Pairs (Single-Ended Outputs Only)**

The sysI/O buffer pairs in the top and bottom banks of the device consist of two single-ended output drivers and two sets of single-ended input buffers (both ratioed and referenced). The referenced input buffer can also be configured as a differential input.

The two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential input buffer and the comp (complementary) pad is associated with the negative side of the differential input buffer.

Only the I/Os on the top and bottom banks have programmable PCI clamps. These I/O banks also support hot socketing with I_{DK} less than 1mA. Note that the PCI clamp is enabled after V_{CC}, V_{CCAUX} and V_{CCIO} are at valid operating levels and the device has been configured.

2. **Left and Right sysI/O Buffer Pairs (Differential and Single-Ended Outputs)**

The sysI/O buffer pairs in the left and right banks of the device consist of two single-ended output drivers, two sets of single-ended input buffers (both ratioed and referenced) and one differential output driver. The referenced input buffer can also be configured as a differential input. In these banks the two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential I/O, and the comp (complementary) pad is associated with the negative side of the differential I/O.

Only the left and right banks have LVDS differential output drivers. See the I_{DK} specification for I/O leakage current during power-up.

Oscillator

Every LatticeECP/EC device has an internal CMOS oscillator which is used to derive a master clock for configuration. The oscillator and the master clock run continuously. The default value of the master clock is 2.5MHz. Table 2-15 lists all the available Master Clock frequencies. When a different Master Clock is selected during the design process, the following sequence takes place:

1. User selects a different Master Clock frequency.
2. During configuration the device starts with the default (2.5MHz) Master Clock frequency.
3. The clock configuration settings are contained in the early configuration bit stream.
4. The Master Clock frequency changes to the selected frequency once the clock configuration bits are received.

For further information about the use of this oscillator for configuration, please see the list of technical documentation at the end of this data sheet.

Table 2-15. Selectable Master Clock (CCLK) Frequencies During Configuration

CCLK (MHz)	CCLK (MHz)	CCLK (MHz)
2.5*	13	45
4.3	15	51
5.4	20	55
6.9	26	60
8.1	30	130
9.2	34	—
10.0	41	—

Density Shifting

The LatticeECP/EC family has been designed to ensure that different density devices in the same package have the same pin-out. Furthermore, the architecture ensures a high success rate when performing design migration from lower density parts to higher density parts. In many cases, it is also possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likely success in each case.

RSDS

The LatticeECP/EC devices support differential RSDS standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The RSDS input standard is supported by the LVDS differential input buffer. The scheme shown in Figure 3-4 is one possible solution for RSDS standard implementation. Use LVDS25E mode with suggested resistors for RSDS operation. Resistor values in Figure 3-4 are industry standard values for 1% resistors.

Figure 3-4. RSDS (Reduced Swing Differential Standard)

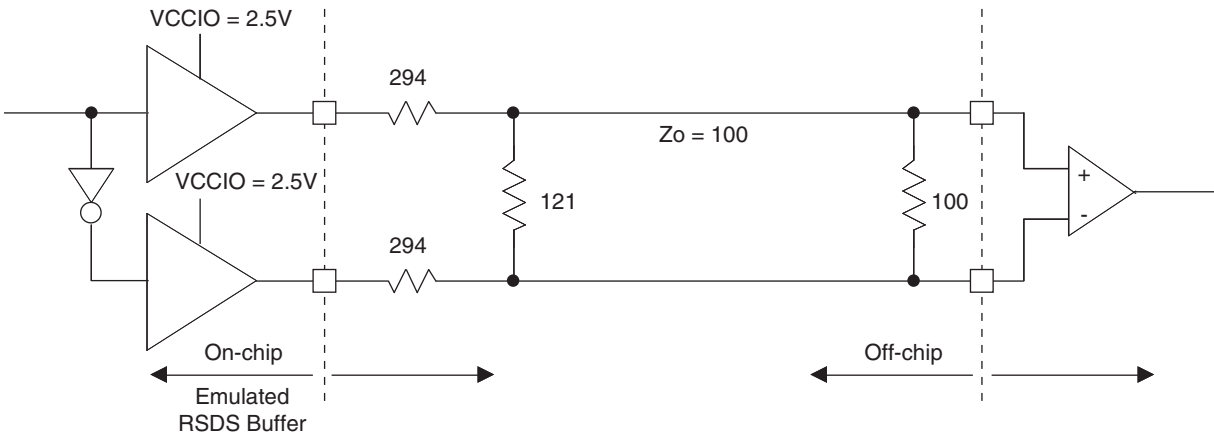
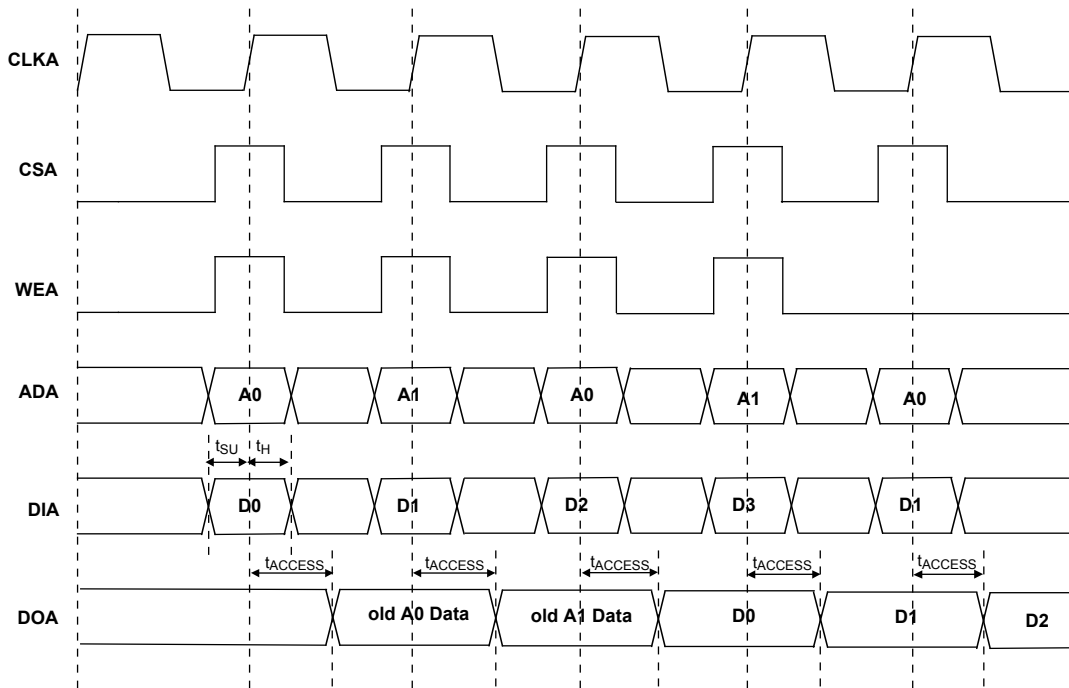


Table 3-4. RSDS DC Conditions

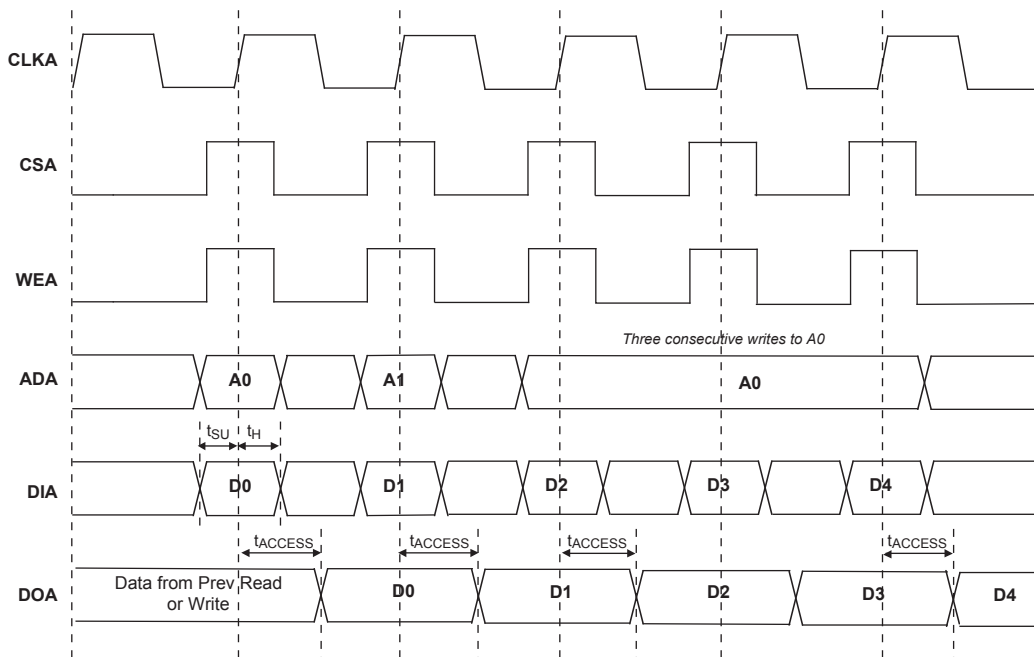
Parameter	Description	Typical	Units
Z_{OUT}	Output impedance	20	ohm
R_S	Driver series resistor	294	ohm
R_P	Driver parallel resistor	121	ohm
R_T	Receiver termination	100	ohm
V_{OH}	Output high voltage	1.35	V
V_{OL}	Output low voltage	1.15	V
V_{OD}	Output differential voltage	0.20	V
V_{CM}	Output common mode voltage	1.25	V
Z_{BACK}	Back impedance	101.5	ohm
I_{DC}	DC output current	3.66	mA

Figure 3-10. Read Before Write (SP Read/Write on Port A, Input Registers Only)



Note: Input data and address are registered at the positive edge of the clock and output data appears after the positive edge of the clock.

Figure 3-11. Write Through (SP Read/Write On Port A, Input Registers Only)



Note: Input data and address are registered at the positive edge of the clock and output data appears after the positive edge of the clock.

LFEC1, LFEC3 Logic Signal Connections: 208 PQFP (Cont.)

Pin Number	LFEC1				LFEC3			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
169	PT13A	1	T		PT21A	1	T	
170	PT12B	1	C		PT20B	1	C	
171	PT12A	1	T		PT20A	1	T	
172	PT11B	1	C	VREF2_1	PT19B	1	C	VREF2_1
173	PT11A	1	T	VREF1_1	PT19A	1	T	VREF1_1
174	PT10B	1	C		PT18B	1	C	
175	PT10A	1	T		PT18A	1	T	
176	VCCIO1	1			VCCIO1	1		
177	VCCAUX	-			VCCAUX	-		
178	PT9B	0	C	PCLKC0_0	PT17B	0	C	PCLKC0_0
179	GND0	0			GND0	0		
180	PT9A	0	T	PCLKT0_0	PT17A	0	T	PCLKT0_0
181	PT8B	0	C	VREF1_0	PT16B	0	C	VREF1_0
182	PT8A	0	T	VREF2_0	PT16A	0	T	VREF2_0
183	PT7B	0	C		PT15B	0	C	
184	PT7A	0	T		PT15A	0	T	
185	PT6B	0	C		PT14B	0	C	
186	PT6A	0	T	TDQS6	PT14A	0	T	TDQS14
187	VCCIO0	0			VCCIO0	0		
188	PT5B	0	C		PT13B	0	C	
189	NC	-			GND0	0		
190	PT5A	0	T		PT13A	0	T	
191	PT4B	0	C		PT12B	0	C	
192	PT4A	0	T		PT12A	0	T	
193	PT3B	0	C		PT11B	0	C	
194	PT3A	0	T		PT11A	0	T	
195	PT2B	0	C		PT10B	0	C	
196	PT2A	0	T		PT10A	0	T	
197	NC	-			VCCIO0	0		
198	NC	-			PT6B	0	C	
199	NC	-			PT6A	0	T	TDQS6
200	NC	-			PT5B	0	C	
201	NC	-			PT5A	0	T	
202	NC	-			PT4B	0	C	
203	NC	-			PT4A	0	T	
204	NC	-			PT3B	0	C	
205	NC	-			PT3A	0	T	
206	NC	-			PT2B	0	C	
207	NC	-			PT2A	0	T	
208	VCCIO0	0			VCCIO0	0		

* Double bonded to the pin.

LFCEP/EC6, LFCEP/EC10 Logic Signal Connections: 208 PQFP (Cont.)

Pin Number	LFCEP6/LFCEC6				LFCEP10/LFCEC10			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
85	VCCIO4	4			VCCIO4	4		
86	PB18A	4	T	WRITEN	PB26A	4	T	WRITEN
87	PB18B	4	C	CS1N	PB26B	4	C	CS1N
88	PB19A	4	T	VREF1_4	PB27A	4	T	VREF1_4
89	PB19B	4	C	CSN	PB27B	4	C	CSN
90	PB20A	4	T	VREF2_4	PB28A	4	T	VREF2_4
91	PB20B	4	C	D0/SPID7	PB28B	4	C	D0/SPID7
92	PB21A	4	T	D2/SPID5	PB29A	4	T	D2/SPID5
93	GND4	4			GND4	4		
94	PB21B	4	C	D1/SPID6	PB29B	4	C	D1/SPID6
95	PB22A	4	T	BDQS22	PB30A	4	T	BDQS30
96	PB22B	4	C	D3/SPID4	PB30B	4	C	D3/SPID4
97	PB23A	4	T		PB31A	4	T	
98	PB23B	4	C	D4/SPID3	PB31B	4	C	D4/SPID3
99	PB24A	4	T		PB32A	4	T	
100	PB24B	4	C	D5/SPID2	PB32B	4	C	D5/SPID2
101	PB25A	4	T		PB33A	4	T	
102	PB25B	4	C	D6/SPID1	PB33B	4	C	D6/SPID1
103	PB33A	4			PB41A	4		
104	VCCIO4	4			VCCIO4	4		
105*	GND3 GND4	-			GND3 GND4	-		
106	VCCIO3	3			VCCIO3	3		
107	PR27B	3	C	VREF2_3	PR36B	3	C	VREF2_3
108	PR27A	3	T	VREF1_3	PR36A	3	T	VREF1_3
109	PR26B	3	C		PR35B	3	C	
110	PR26A	3	T		PR35A	3	T	
111	PR25B	3	C		PR34B	3	C	
112	PR25A	3	T		PR34A	3	T	
113	PR24B	3	C		PR33B	3	C	
114	PR24A	3	T	RDQS24	PR33A	3	T	RDQS33
115	PR23B	3	C	RLM0_PLLC_FB_A	PR32B	3	C	RLM0_PLLC_FB_A
116	GND3	3			GND3	3		
117	PR23A	3	T	RLM0_PLLT_FB_A	PR32A	3	T	RLM0_PLLT_FB_A
118	PR22B	3	C	RLM0_PLLC_IN_A	PR31B	3	C	RLM0_PLLC_IN_A
119	PR22A	3	T	RLM0_PLLT_IN_A	PR31A	3	T	RLM0_PLLT_IN_A
120	VCCIO3	3			VCCIO3	3		
121	PR21B	3	C	DI/CSSPIN	PR30B	3	C	DI/CSSPIN
122	PR21A	3	T	DOUT/CSON	PR30A	3	T	DOUT/CSON
123	PR20B	3	C	BUSY/SISPI	PR29B	3	C	BUSY/SISPI
124	PR20A	3	T	D7/SPID0	PR29A	3	T	D7/SPID0
125	CFG2	3			CFG2	3		
126	CFG1	3			CFG1	3		

LFEC3 and LFECP/EC6 Logic Signal Connections: 256 fpBGA

Ball Number	LFEC3				LFECP6/LFEC6			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
GND	GND7	7			GND7	7		
D4	PL2A	7	T	VREF2_7	PL2A	7	T	VREF2_7
D3	PL2B	7	C	VREF1_7	PL2B	7	C	VREF1_7
C3	PL3A	7	T		PL3A	7	T	
C2	PL3B	7	C		PL3B	7	C	
B1	PL4A	7	T		PL4A	7	T	
C1	PL4B	7	C		PL4B	7	C	
E3	PL5A	7	T		PL5A	7	T	
E4	PL5B	7	C		PL5B	7	C	
F4	PL6A	7	T	LDQS6	PL6A	7	T	LDQS6
F5	PL6B	7	C		PL6B	7	C	
G4	PL7A	7	T		PL7A	7	T	
G3	PL7B	7	C		PL7B	7	C	
D2	PL8A	7	T		PL8A	7	T	
D1	PL8B	7	C		PL8B	7	C	
E1	PL9A	7	T	PCLKT7_0	PL9A	7	T	PCLKT7_0
GND	GND7	7			GND7	7		
E2	PL9B	7	C	PCLKC7_0	PL9B	7	C	PCLKC7_0
F3	XRES	6			XRES	6		
G5	NC	-			PL11A	6	T	
H5	NC	-			PL11B	6	C	
F2	NC	-			PL12A	6	T	
F1	NC	-			PL12B	6	C	
H4	NC	-			PL13A	6	T	
H3	NC	-			PL13B	6	C	
G2	NC	-			PL14A	6	T	
-	-	-			GND6	6		
G1	NC	-			PL14B	6	C	
J4	NC	-			PL15A	6	T	LDQS15
J3	NC	-			PL15B	6	C	
J5	NC	-			PL16A	6	T	
K5	NC	-			PL16B	6	C	
H2	NC	-			PL17A	6	T	
H1	NC	-			PL17B	6	C	
J2	NC	-			PL18A	6	T	
-	-	-			GND6	6		
J1	NC	-			PL18B	6	C	
K4	TCK	6			TCK	6		
K3	TDI	6			TDI	6		
L3	TMS	6			TMS	6		
L5	TDO	6			TDO	6		
L4	VCCJ	6			VCCJ	6		

LFECP/EC10 and LFECP/EC15 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFECP10/LFEC10				LFECP15/LFEC15			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
N7	PB18B	5	C		PB18B	5	C	
R7	PB19A	5	T		PB19A	5	T	
R8	PB19B	5	C		PB19B	5	C	
M7	PB20A	5	T		PB20A	5	T	
M8	PB20B	5	C		PB20B	5	C	
T8	PB21A	5	T		PB21A	5	T	
GND	GND5	5			GND5	5		
T9	PB21B	5	C		PB21B	5	C	
P8	PB22A	5	T	BDQS22	PB22A	5	T	BDQS22
N8	PB22B	5	C		PB22B	5	C	
R9	PB23A	5	T		PB23A	5	T	
R10	PB23B	5	C		PB23B	5	C	
P9	PB24A	5	T	VREF2_5	PB24A	5	T	VREF2_5
N9	PB24B	5	C	VREF1_5	PB24B	5	C	VREF1_5
T10	PB25A	5	T	PCLKT5_0	PB25A	5	T	PCLKT5_0
GND	GND5	5			GND5	5		
T11	PB25B	5	C	PCLKC5_0	PB25B	5	C	PCLKC5_0
T12	PB26A	4	T	WRITEN	PB26A	4	T	WRITEN
T13	PB26B	4	C	CS1N	PB26B	4	C	CS1N
P10	PB27A	4	T	VREF1_4	PB27A	4	T	VREF1_4
N10	PB27B	4	C	CSN	PB27B	4	C	CSN
T14	PB28A	4	T	VREF2_4	PB28A	4	T	VREF2_4
T15	PB28B	4	C	D0/SPID7	PB28B	4	C	D0/SPID7
M10	PB29A	4	T	D2/SPID5	PB29A	4	T	D2/SPID5
GND	GND4	4			GND4	4		
M11	PB29B	4	C	D1/SPID6	PB29B	4	C	D1/SPID6
R11	PB30A	4	T	BDQS30	PB30A	4	T	BDQS30
P11	PB30B	4	C	D3/SPID4	PB30B	4	C	D3/SPID4
R13	PB31A	4	T		PB31A	4	T	
R14	PB31B	4	C	D4/SPID3	PB31B	4	C	D4/SPID3
P12	PB32A	4	T		PB32A	4	T	
P13	PB32B	4	C	D5/SPID2	PB32B	4	C	D5/SPID2
N11	PB33A	4	T		PB33A	4	T	
GND	GND4	4			GND4	4		
N12	PB33B	4	C	D6/SPID1	PB33B	4	C	D6/SPID1
R12	PB34A	4			PB34A	4		
GND	GND4	4			GND4	4		
GND	GND4	4			GND4	4		
-	-	-			GND4	4		
-	-	-			GND4	4		
GND	GND3	3			GND3	3		
N13	PR36B	3	C	VREF2_3	PR44B	3	C	VREF2_3
N14	PR36A	3	T	VREF1_3	PR44A	3	T	VREF1_3

**LFECP/EC6, LFECP/EC10, LFECP/EC15 Logic Signal Connections:
 484 fpBGA**

LFECP6/LFEC6					LFECP10/LFEC10					LFECP/LFEC15				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
GND	GND7	7			GND	GND7	7			GND	GND7	7		
D4	PL2A	7	T	VREF2_7	D4	PL2A	7	T	VREF2_7	D4	PL2A	7	T	VREF2_7
E4	PL2B	7	C	VREF1_7	E4	PL2B	7	C	VREF1_7	E4	PL2B	7	C	VREF1_7
C3	NC	-			C3	PL3A	7	T		C3	PL3A	7	T	
B2	NC	-			B2	PL3B	7	C		B2	PL3B	7	C	
E5	NC	-			E5	PL4A	7	T		E5	PL4A	7	T	
F5	NC	-			F5	PL4B	7	C		F5	PL4B	7	C	
D3	NC	-			D3	PL5A	7	T		D3	PL5A	7	T	
C2	NC	-			C2	PL5B	7	C		C2	PL5B	7	C	
F4	NC	-			F4	PL6A	7	T	LDQS6	F4	PL6A	7	T	LDQS6
G4	NC	-			G4	PL6B	7	C		G4	PL6B	7	C	
E3	NC	-			E3	PL7A	7	T		E3	PL7A	7	T	
D2	NC	-			D2	PL7B	7	C		D2	PL7B	7	C	
B1	NC	-			B1	PL8A	7	T	LUM0_PLLT_IN_A	B1	PL8A	7	T	LUM0_PLLT_IN_A
C1	NC	-			C1	PL8B	7	C	LUM0_PLLC_IN_A	C1	PL8B	7	C	LUM0_PLLC_IN_A
F3	NC	-			F3	PL9A	7	T	LUM0_PLLT_FB_A	F3	PL9A	7	T	LUM0_PLLT_FB_A
GND	-	-			GND	GND7	7			GND	GND7	7		
E2	NC	-			E2	PL9B	7	C	LUM0_PLLC_FB_A	E2	PL9B	7	C	LUM0_PLLC_FB_A
G5	NC	-			G5	NC	-			G5	PL11A	7	T	
H6	NC	-			H6	NC	-			H6	PL11B	7	C	
G3	NC	-			G3	NC	-			G3	PL12A	7	T	
H4	NC	-			H4	NC	-			H4	PL12B	7	C	
J5	NC	-			J5	NC	-			J5	PL13A	7	T	
H5	NC	-			H5	NC	-			H5	PL13B	7	C	
F2	NC	-			F2	NC	-			F2	PL14A	7	T	
GND	-	-			GND	-	-			GND	GND7	7		
F1	NC	-			F1	NC	-			F1	PL14B	7	C	
E1	NC	-			E1	PL11A	7	T		E1	PL15A	7	T	
D1	NC	-			D1	PL11B	7	C		D1	PL15B	7	C	
H3	PL3A	7	T		H3	PL12A	7	T		H3	PL16A	7	T	
G2	PL3B	7	C		G2	PL12B	7	C		G2	PL16B	7	C	
H2	PL4A	7	T		H2	PL13A	7	T		H2	PL17A	7	T	
G1	PL4B	7	C		G1	PL13B	7	C		G1	PL17B	7	C	
J4	PL5A	7	T		J4	PL14A	7	T		J4	PL18A	7	T	
GND	-	-			GND	GND7	7			GND	GND7	7		
J3	PL5B	7	C		J3	PL14B	7	C		J3	PL18B	7	C	
J2	PL6A	7	T	LDQS6	J2	PL15A	7	T	LDQS15	J2	PL19A	7	T	LDQS19
H1	PL6B	7	C		H1	PL15B	7	C		H1	PL19B	7	C	
K4	PL7A	7	T		K4	PL16A	7	T		K4	PL20A	7	T	
K5	PL7B	7	C		K5	PL16B	7	C		K5	PL20B	7	C	
K3	PL8A	7	T		K3	PL17A	7	T		K3	PL21A	7	T	
K2	PL8B	7	C		K2	PL17B	7	C		K2	PL21B	7	C	
J1	PL9A	7	T	PCLKT7_0	J1	PL18A	7	T	PCLKT7_0	J1	PL22A	7	T	PCLKT7_0
GND	GND7	7			GND	GND7	7			GND	GND7	7		
K1	PL9B	7	C	PCLKC7_0	K1	PL18B	7	C	PCLKC7_0	K1	PL22B	7	C	PCLKC7_0
L3	XRES	6			L3	XRES	6			L3	XRES	6		
L4	PL11A	6	T		L4	PL20A	6	T		L4	PL24A	6	T	
L5	PL11B	6	C		L5	PL20B	6	C		L5	PL24B	6	C	
L2	PL12A	6	T		L2	PL21A	6	T		L2	PL25A	6	T	
L1	PL12B	6	C		L1	PL21B	6	C		L1	PL25B	6	C	

LFEC20/EC20 and LFEC20/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFEC20/EC20					LFEC20/EC33				
Ball Number	Ball Function	Bank	LVD S	Dual Function	Ball Number	Ball Function	Bank	LVD S	Dual Function
W20	PR48B	3	C	VREF2_3	W20	PR68B	3	C	VREF2_3
Y20	PR48A	3	T	VREF1_3	Y20	PR68A	3	T	VREF1_3
GND	-	-			GND	GND3	3		
GND	-	-			GND	GND3	3		
AA21	PR47B	3	C		AA21	PR59B	3	C	
AB21	PR47A	3	T		AB21	PR59A	3	T	
W19	PR46B	3	C		W19	PR58B	3	C	
V19	PR46A	3	T		V19	PR58A	3	T	
Y21	PR45B	3	C		Y21	PR57B	3	C	
AA22	PR45A	3	T	RDQS45	AA22	PR57A	3	T	RDQS57
V20	PR44B	3	C	RLM0_PLLC_IN_A	V20	PR56B	3	C	RLM0_PLLC_IN_A
GND	GND3	3			GND	GND3	3		
U20	PR44A	3	T	RLM0_PLLT_IN_A	U20	PR56A	3	T	RLM0_PLLT_IN_A
W21	PR43B	3	C	RLM0_PLLC_FB_A	W21	PR55B	3	C	RLM0_PLLC_FB_A
Y22	PR43A	3	T	RLM0_PLLT_FB_A	Y22	PR55A	3	T	RLM0_PLLT_FB_A
V21	PR42B	3	C	DI/CSSPIN	V21	PR54B	3	C	DI/CSSPIN
W22	PR42A	3	T	DOUT/CSON	W22	PR54A	3	T	DOUT/CSON
U21	PR41B	3	C	BUSY/SISPI	U21	PR53B	3	C	BUSY/SISPI
V22	PR41A	3	T	D7/SPID0	V22	PR53A	3	T	D7/SPID0
T19	CFG2	3			T19	CFG2	3		
U19	CFG1	3			U19	CFG1	3		
U18	CFG0	3			U18	CFG0	3		
V18	PROGRAMN	3			V18	PROGRAMN	3		
T20	CCLK	3			T20	CCLK	3		
T21	INITN	3			T21	INITN	3		
R20	DONE	3			R20	DONE	3		
GND	GND3	3			GND	GND3	3		
T18	PR37B	3	C		T18	PR49B	3	C	
R17	PR37A	3	T		R17	PR49A	3	T	
R19	PR36B	3	C		R19	PR48B	3	C	
R18	PR36A	3	T	RDQS36	R18	PR48A	3	T	RDQS48
U22	PR35B	3	C		U22	PR47B	3	C	
GND	GND3	3			GND	GND3	3		
T22	PR35A	3	T		T22	PR47A	3	T	
R21	PR34B	3	C		R21	PR46B	3	C	
R22	PR34A	3	T		R22	PR46A	3	T	
P20	PR33B	3	C		P20	PR45B	3	C	
N20	PR33A	3	T		N20	PR45A	3	T	
P19	PR32B	3	C		P19	PR44B	3	C	
P18	PR32A	3	T		P18	PR44A	3	T	
P21	PR31B	3	C		P21	PR43B	3	C	
GND	GND3	3			GND	GND3	3		
P22	PR31A	3	T		P22	PR43A	3	T	
N21	PR30B	3	C		N21	PR42B	3	C	

LFECP/EC20 and LFECP/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFECP20/LFEC20					LFECP/LFEC33				
Ball Number	Ball Function	Bank	LVD S	Dual Function	Ball Number	Ball Function	Bank	LVD S	Dual Function
N22	PR30A	3	T		N22	PR42A	3	T	
N19	PR29B	3	C		N19	PR41B	3	C	
N18	PR29A	3	T		N18	PR41A	3	T	
M21	PR28B	3	C		M21	PR40B	3	C	
L20	PR28A	3	T	RDQS28	L20	PR40A	3	T	RDQS40
L21	PR27B	3	C		L21	PR39B	3	C	
GND	GND3	3			GND	GND3	3		
M20	PR27A	3	T		M20	PR39A	3	T	
M18	PR26B	3	C		M18	PR38B	3	C	
M19	PR26A	3	T		M19	PR38A	3	T	
M22	PR25B	3	C		M22	PR37B	3	C	
L22	PR25A	3	T		L22	PR37A	3	T	
K22	PR24B	3	C		K22	PR36B	3	C	
K21	PR24A	3	T		K21	PR36A	3	T	
J22	PR22B	2	C	PCLKC2_0	J22	PR34B	2	C	PCLKC2_0
GND	GND2	2			GND	GND2	2		
J21	PR22A	2	T	PCLKT2_0	J21	PR34A	2	T	PCLKT2_0
H22	PR21B	2	C		H22	PR33B	2	C	
H21	PR21A	2	T		H21	PR33A	2	T	
L19	PR20B	2	C		L19	PR32B	2	C	
L18	PR20A	2	T		L18	PR32A	2	T	
K20	PR19B	2	C		K20	PR31B	2	C	
J20	PR19A	2	T	RDQS19	J20	PR31A	2	T	RDQS31
K19	PR18B	2	C		K19	PR30B	2	C	
GND	GND2	2			GND	GND2	2		
K18	PR18A	2	T		K18	PR30A	2	T	
G22	PR17B	2	C		G22	PR29B	2	C	
F22	PR17A	2	T		F22	PR29A	2	T	
F21	PR16B	2	C		F21	PR28B	2	C	
E22	PR16A	2	T		E22	PR28A	2	T	
E21	PR15B	2	C		E21	PR27B	2	C	
D22	PR15A	2	T		D22	PR27A	2	T	
G21	PR14B	2	C		G21	PR26B	2	C	
G20	PR14A	2	T		G20	PR26A	2	T	
GND	GND2	2			GND	GND2	2		
J18	PR13B	2	C		J18	PR25B	2	C	
H19	PR13A	2	T		H19	PR25A	2	T	
J19	PR12B	2	C		J19	PR24B	2	C	
H20	PR12A	2	T		H20	PR24A	2	T	
H17	PR11B	2	C		H17	PR23B	2	C	
H18	PR11A	2	T		H18	PR23A	2	T	RDQS23
D21	PR9B	2	C	RUM0_PLLC_FB_A	D21	PR17B	2	C	RUM0_PLLC_FB_A
GND	GND2	2			GND	GND2	2		
GND	-	-			GND	GND2	2		

LatticeECP Commercial (Continued)

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFECP33E-3F484C	360	-3	fpBGA	484	COM	32.8K
LFECP33E-4F484C	360	-4	fpBGA	484	COM	32.8K
LFECP33E-5F484C	360	-5	fpBGA	484	COM	32.8K

LatticeEC Industrial

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC1E-3Q208I	112	-3	PQFP	208	IND	1.5K
LFEC1E-4Q208I	112	-4	PQFP	208	IND	1.5K
LFEC1E-3T144I	97	-3	TQFP	144	IND	1.5K
LFEC1E-4T144I	97	-4	TQFP	144	IND	1.5K
LFEC1E-3T100I	67	-3	TQFP	100	IND	1.5K
LFEC1E-4T100I	67	-4	TQFP	100	IND	1.5K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC3E-3F256I	160	-3	fpBGA	256	IND	3.1K
LFEC3E-4F256I	160	-4	fpBGA	256	IND	3.1K
LFEC3E-3Q208I	145	-3	PQFP	208	IND	3.1K
LFEC3E-4Q208I	145	-4	PQFP	208	IND	3.1K
LFEC3E-3T144I	97	-3	TQFP	144	IND	3.1K
LFEC3E-4T144I	97	-4	TQFP	144	IND	3.1K
LFEC3E-3T100I	67	-3	TQFP	100	IND	3.1K
LFEC3E-4T100I	67	-4	TQFP	100	IND	3.1K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC6E-3F484I	224	-3	fpBGA	484	IND	6.1K
LFEC6E-4F484I	224	-4	fpBGA	484	IND	6.1K
LFEC6E-3F256I	195	-3	fpBGA	256	IND	6.1K
LFEC6E-4F256I	195	-4	fpBGA	256	IND	6.1K
LFEC6E-3Q208I	147	-3	PQFP	208	IND	6.1K
LFEC6E-4Q208I	147	-4	PQFP	208	IND	6.1K
LFEC6E-3T144I	97	-3	TQFP	144	IND	6.1K
LFEC6E-4T144I	97	-4	TQFP	144	IND	6.1K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC10E-3F484I	288	-3	fpBGA	484	IND	10.2K
LFEC10E-4F484I	288	-4	fpBGA	484	IND	10.2K
LFEC10E-3F256I	195	-3	fpBGA	256	IND	10.2K
LFEC10E-4F256I	195	-4	fpBGA	256	IND	10.2K
LFEC10E-3 P208I	147	-3	PQFP	208	IND	10.2K
LFEC10E-4 P208I	147	-4	PQFP	208	IND	10.2K

Lead-Free Packaging
LatticeEC Commercial

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC1E-3QN208C	112	-3	Lead-Free PQFP	208	COM	1.5K
LFEC1E-4QN208C	112	-4	Lead-Free PQFP	208	COM	1.5K
LFEC1E-5QN208C	112	-5	Lead-Free PQFP	208	COM	1.5K
LFEC1E-3TN144C	97	-3	Lead-Free TQFP	144	COM	1.5K
LFEC1E-4TN144C	97	-4	Lead-Free TQFP	144	COM	1.5K
LFEC1E-5TN144C	97	-5	Lead-Free TQFP	144	COM	1.5K
LFEC1E-3TN100C	67	-3	Lead-Free TQFP	100	COM	1.5K
LFEC1E-4TN100C	67	-4	Lead-Free TQFP	100	COM	1.5K
LFEC1E-5TN100C	67	-5	Lead-Free TQFP	100	COM	1.5K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC3E-3FN256C	160	-3	Lead-Free fpBGA	256	COM	3.1K
LFEC3E-4FN256C	160	-4	Lead-Free fpBGA	256	COM	3.1K
LFEC3E-5FN256C	160	-5	Lead-Free fpBGA	256	COM	3.1K
LFEC3E-3QN208C	145	-3	Lead-Free PQFP	208	COM	3.1K
LFEC3E-4QN208C	145	-4	Lead-Free PQFP	208	COM	3.1K
LFEC3E-5QN208C	145	-5	Lead-Free PQFP	208	COM	3.1K
LFEC3E-3TN144C	97	-3	Lead-Free TQFP	144	COM	3.1K
LFEC3E-4TN144C	97	-4	Lead-Free TQFP	144	COM	3.1K
LFEC3E-5TN144C	97	-5	Lead-Free TQFP	144	COM	3.1K
LFEC3E-3TN100C	67	-3	Lead-Free TQFP	100	COM	3.1K
LFEC3E-4TN100C	67	-4	Lead-Free TQFP	100	COM	3.1K
LFEC3E-5TN100C	67	-5	Lead-Free TQFP	100	COM	3.1K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC6E-3FN484C	224	-3	Lead-Free fpBGA	484	COM	6.1K
LFEC6E-4FN484C	224	-4	Lead-Free fpBGA	484	COM	6.1K
LFEC6E-5FN484C	224	-5	Lead-Free fpBGA	484	COM	6.1K
LFEC6E-3FN256C	195	-3	Lead-Free fpBGA	256	COM	6.1K
LFEC6E-4FN256C	195	-4	Lead-Free fpBGA	256	COM	6.1K
LFEC6E-5FN256C	195	-5	Lead-Free fpBGA	256	COM	6.1K
LFEC6E-3QN208C	147	-3	Lead-Free PQFP	208	COM	6.1K
LFEC6E-4QN208C	147	-4	Lead-Free PQFP	208	COM	6.1K
LFEC6E-5QN208C	147	-5	Lead-Free PQFP	208	COM	6.1K
LFEC6E-3TN144C	97	-3	Lead-Free TQFP	144	COM	6.1K
LFEC6E-4TN144C	97	-4	Lead-Free TQFP	144	COM	6.1K
LFEC6E-5TN144C	97	-5	Lead-Free TQFP	144	COM	6.1K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC10E-3FN484C	288	-3	Lead-Free fpBGA	484	COM	10.2K
LFEC10E-4FN484C	288	-4	Lead-Free fpBGA	484	COM	10.2K
LFEC10E-5FN484C	288	-5	Lead-Free fpBGA	484	COM	10.2K
LFEC10E-3FN256C	195	-3	Lead-Free fpBGA	256	COM	10.2K

LatticeECP Commercial (Continued)

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC33E-3FN484C	360	-3	Lead-Free fpBGA	484	COM	32.8K
LFEC33E-4FN484C	360	-4	Lead-Free fpBGA	484	COM	32.8K
LFEC33E-5FN484C	360	-5	Lead-Free fpBGA	484	COM	32.8K

LatticeEC Industrial

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC1E-3QN208I	112	-3	Lead-Free PQFP	208	IND	1.5K
LFEC1E-4QN208I	112	-4	Lead-Free PQFP	208	IND	1.5K
LFEC1E-3TN144I	97	-3	Lead-Free TQFP	144	IND	1.5K
LFEC1E-4TN144I	97	-4	Lead-Free TQFP	144	IND	1.5K
LFEC1E-3TN100I	67	-3	Lead-Free TQFP	100	IND	1.5K
LFEC1E-4TN100I	67	-4	Lead-Free TQFP	100	IND	1.5K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC3E-3FN256I	160	-3	Lead-Free fpBGA	256	IND	3.1K
LFEC3E-4FN256I	160	-4	Lead-Free fpBGA	256	IND	3.1K
LFEC3E-3QN208I	145	-3	Lead-Free PQFP	208	IND	3.1K
LFEC3E-4QN208I	145	-4	Lead-Free PQFP	208	IND	3.1K
LFEC3E-3TN144I	97	-3	Lead-Free TQFP	144	IND	3.1K
LFEC3E-4TN144I	97	-4	Lead-Free TQFP	144	IND	3.1K
LFEC3E-3TN100I	67	-3	Lead-Free TQFP	100	IND	3.1K
LFEC3E-4TN100I	67	-4	Lead-Free TQFP	100	IND	3.1K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC6E-3FN484I	224	-3	Lead-Free fpBGA	484	IND	6.1K
LFEC6E-4FN484I	224	-4	Lead-Free fpBGA	484	IND	6.1K
LFEC6E-3FN256I	195	-3	Lead-Free fpBGA	256	IND	6.1K
LFEC6E-4FN256I	195	-4	Lead-Free fpBGA	256	IND	6.1K
LFEC6E-3QN208I	147	-3	Lead-Free PQFP	208	IND	6.1K
LFEC6E-4QN208I	147	-4	Lead-Free PQFP	208	IND	6.1K
LFEC6E-3TN144I	97	-3	Lead-Free TQFP	144	IND	6.1K
LFEC6E-4TN144I	97	-4	Lead-Free TQFP	144	IND	6.1K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC10E-3FN484I	288	-3	Lead-Free fpBGA	484	IND	10.2K
LFEC10E-4FN484I	288	-4	Lead-Free fpBGA	484	IND	10.2K
LFEC10E-3FN256I	195	-3	Lead-Free fpBGA	256	IND	10.2K
LFEC10E-4FN256I	195	-4	Lead-Free fpBGA	256	IND	10.2K
LFEC10E-3QN208I	147	-3	Lead-Free PQFP	208	IND	10.2K
LFEC10E-4QN208I	147	-4	Lead-Free PQFP	208	IND	10.2K

Revision History

Date	Version	Section	Change Summary
June 2004	01.0	—	Initial release.
August 2004	01.1	Introduction	Added new device LFECP/LFEC33 in Table 1-1.
		Architecture	Added New device LFECP/LFEC33 in Tables 2-9, 2-10 and 2-11.
		DC & Switching Characteristics	Added New device LFECP/LFEC33 on Supply current (Standby) tables.
			Added New device LFECP/LFEC33 on Initialization Supply current tables.
Ordering Information	Added 33K Logic Capacity Device in Part Number Description section.		
	Added EC33, ECP33 device: Industrial and Commercial to Part Number table.		
	Corrected I/O counts in the part number tables for 100/144 TQFP and 208 PQFP packages to match Table 1-1 on page 1.		
November 2004	01.3	Introduction	Changed DDR333 (166MHz) to DDR400 (200MHz)
			Added "RSDS" offering to the Features list: Flexible I/O Buffer
		Architecture	Added information about Secondary Clock Sources
			Added information about DCS
			Added a section on "Recommended Power-up Sequence"
			Updated Figure 2-24 "DQS Routing"
			Added DSP Block performance numbers to Table 2-11
			Added another row for RSDS in Table 2-13 and Table 2-14
		DC & Switching Characteristics	Updated new timing numbers
			Added numbers to derating table
			Added DC conditions to RSDS table
			Changed LVDS Max. V_{CCIO} to 2.625
			Added a row for RSDS in "Operating Condition" table
			Updated standby and initialization current table
			Added figure 3-12: sysConfig SPI port sequence
			Added DDR Timing Table and DDR Timings Figure 3-6
		Pinout Information	Added LFECP/EC6 to Pin Information
			Added LFECP/EC6 to Power Supply and NC Connections
			Added LFECP/EC6 144 TQFP Logic Signal Connections
			Added LFECP/EC6 208 PQFP Logic Signal Connections
			Added LFECP/EC6 256 fpBGA Logic Signal Connections
			Added LFECP/EC6 484 fpBGA Logic Signal Connections
		Ordering Information	Added 33K Logic Capacity Device in Part Number Description section.
			Added Part Number table for Commercial EC33.
Added Part Number table for Commercial ECP33.			
Added Part Number table for Industrial EC33.			
			Added Part Number table for Industrial ECP33.